

## HMC1096LP3E

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## GaAs pHEMT MMIC X2 ACTIVE FREQUENCY MULTIPLIER, 3.8 - 5.6 GHz OUTPUT

#### Typical Applications

The HMC1096LP3E is suitable for:

- Point-to-Point & VSAT Radios
- Test Instrumentation
- Military & Space

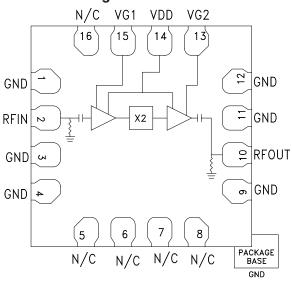
#### **Features**

High Output Power: 12 dBm

Low Input Power Drive: -2 to +5 dBm

Fo, 3 Fo Isolation: +22 dBc Single Supply: +5V @100 mA 16 Lead 3 x 3 mm SMT Package

#### **Functional Diagram**



#### **General Description**

The HMC1096LP3E is a x2 active broadband frequency multiplier utilizing GaAs technology in a leadless RoHS compliant Low Stress Injection Molded Plastic SMT package. When driven by a 0 dBm signal, the multiplier provides +12 dBm typical output power from 3.8 to 5.6 GHz. The Fo and 3 Fo isolations are 22 dBc with respect to the output signal level. This frequency multiplier features DC blocked I/Os, and is ideal for use in LO multiplier chains for Point-to-Point & VSAT radios yielding reduced parts count vs. traditional approaches. The HMC1096LP3E is compatible with surface mount manufacturing techniques.

## Electrical Specifications, $T_A = +25^{\circ}$ C, VDD = +5 V, 0 dBm Drive Level [1]

Parameter	Min.	Тур.	Max.	Units
Frequency Range, Input	1.9		2.8	GHz
Frequency Range, Output	3.8		5.6	GHz
Output Power	9	12		dBm
Fo, 3 Fo Isolation (with respect to output level)		22		dBc
Phase Noise (@ 10 KHz Offset)		-142		dBc / Hz
Input Return Loss		12		dB
Output Return Loss		8		dB
Supply Current [1]		100		mA

[1] External resistors R1 and R2 set the typical bias level for VG1 to 1.22 Vdc, 1.4mA and VG2 to 1.04 Vdc, 1.2 mA to achieve drain current of 100mA.

## **HMC1096\* PRODUCT PAGE QUICK LINKS**

Last Content Update: 02/23/2017

## COMPARABLE PARTS 🖵

View a parametric search of comparable parts.

## **EVALUATION KITS**

· HMC1096 Evaluation Board

## **DOCUMENTATION**

#### **Data Sheet**

 HMC1096LP3E: GaAs pHEMT MMIC X2 Active Frequency Multiplier, 3.8 - 5.6 GHz Output Data Sheet

## TOOLS AND SIMULATIONS -

HMC1096 S-Parameter

## DESIGN RESOURCES 🖵

- HMC1096 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

#### **DISCUSSIONS**

View all HMC1096 EngineerZone Discussions.

### SAMPLE AND BUY

Visit the product page to see pricing options.

## TECHNICAL SUPPORT 🖳

Submit a technical question or find your regional support number.

#### DOCUMENT FEEDBACK 🖳

Submit feedback for this data sheet.

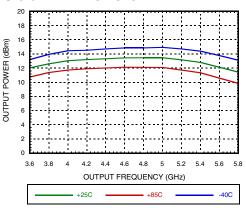
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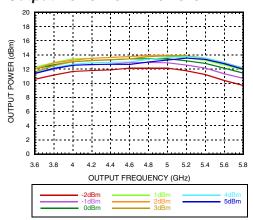
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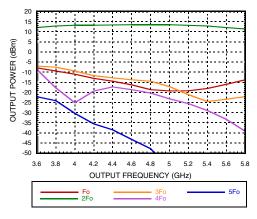
## Output Power vs. Temperature @ 0 dBm Drive Level



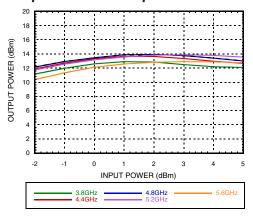
#### **Output Power vs. Drive Level**



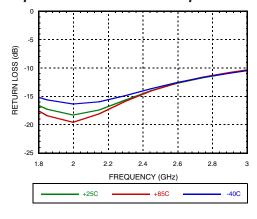
#### Isolation @ 0 dBm Drive Level



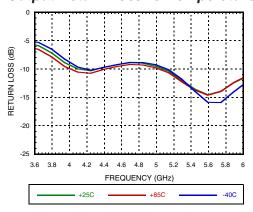
#### **Output Power vs. Input Power**



#### Input Return Loss vs. Temperature



#### **Output Return Loss vs. Temperature**

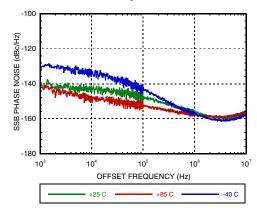




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#### Phase Noise vs. Temperature @ 4.7 GHz





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#### **Absolute Maximum Ratings**

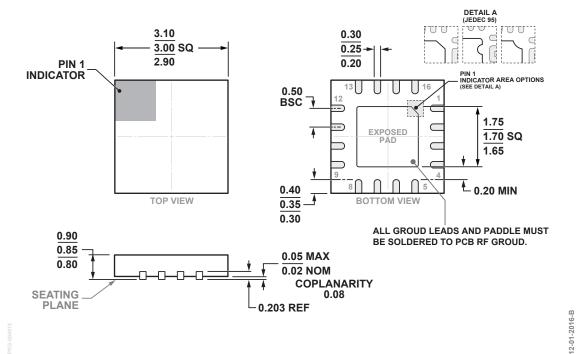
RF Input Power	+5 dBm
Supply Voltage (VDD)	+6 V
VG1, VG2 (Bias Input)	+2 V
Channel Temperature	175 °C
Continuous Pdiss (T= 85 °C) (derate 13.3 / mW / °C above 85 °C)	1.2 W
Thermal Resistance (channel to package bottom)	75 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 0, passed 150 V

#### Typical Supply Current vs. VDD

VDD (Vdc)	IDD (mA)	
5.0	100	



#### **Outline Drawing**



## Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating [2]	Package Marking [1]
HMC1096LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1	<u>H1096</u> XXXX

<sup>[1] 4-</sup>Digit lot number XXXX

<sup>[2]</sup> Max peak reflow temperature of 260 °C



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# GaAs pHEMT MMIC X2 ACTIVE FREQUENCY MULTIPLIER, 3.8 - 5.6 GHz OUTPUT

#### **Pin Descriptions**

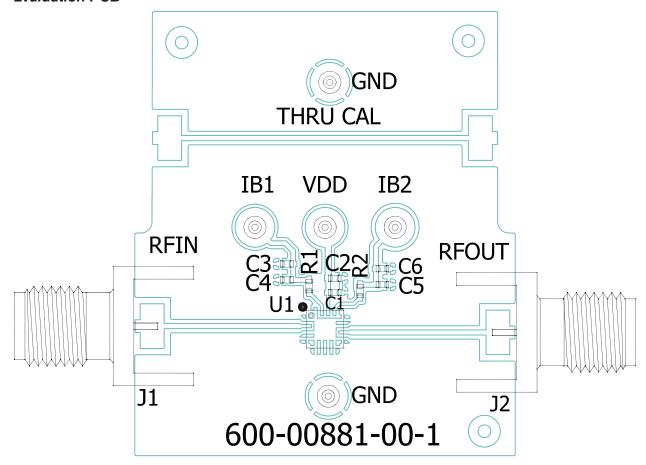
Pin Number	Function	Description	Pin Schematic	
1, 3, 4, 9, 11, 12	GND	Package Bottom must be connected to RF/DC ground.	O GND	
5, 6, 7, 8, 16	N/C	These pins are not connected internally.  However, this product was specified with these pins connected to RF/DC ground.		
2	RFIN	This pin is dc-coupled internally and matched to 50 Ohms.  The resistor is used for ESD protection.	RFIN O	
10	RFOUT	This pin is dc-coupled internally and matched to 50 Ohms. The resistor is used for ESD protection.		
13, 15	VG2, VG1	Gate Voltage for first and second stage LO amplifier. Recommended DC voltage is +5 V at J5/J7 with bias resistors R1 and R2 applied. Typical. Refer to application circuit for required external components.	VDD  VG1, VG2	
14	VDD	Supply voltage for first and second stage LO amplifier. Recommended DC voltage is +5 V with external bypass capacitors of 100 pF and 10 nF applied. Refer to application circuit for required external components.	¥ '	



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## GaAs phemt mmic X2 Active frequency Multiplier, 3.8 - 5.6 GHz Output

#### **Evaluation PCB**



#### List of Materials for Evaluation PCB EV1HMC1096LP3[1]

Item	Description
J1, J2	PCB Mount SMA RF Connector
J5 - J9	DC PIN
C1, C3, C5	100 pF Capacitor, 0402 Pkg.
C2, C4, C6	10000 pF Capacitor, 0402 Pkg.
R1	2.70K Ohm Resistor, 0402 Pkg.
R2	3.30K Ohm Resistor, 0402 Pkg.
U1	HMC1096LP3E
PCB <sup>[1]</sup>	600-00881-00 Evaluation Board

[1] Circuit Board Material: Rogers 4350 or Arlon 25FR

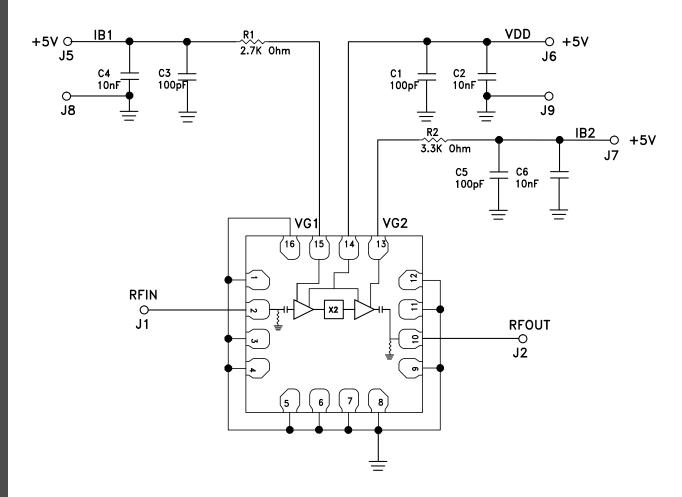
The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



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#### **Application Circuit**





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Notes: